

PF8121F1 - NXP General Configuration report for PF8121 OTP program ID: F1 Rev. 1.0 — 13 March 2019

Report

General description 1

The PF8121 is a power management integrated circuit (PMIC) designed for high performance i.MX 8 and S32V based applications. It features seven high efficiency buck converters and four linear regulators for powering the processor, memory and miscellaneous peripherals.

Built-in one time programmable memory stores key startup configurations, drastically reducing external components typically used to set output voltage and sequence of external regulators. Regulator parameters are adjustable through high-speed I²C after start up offering flexibility for different system states.

Note: Electrical characteristics are mantained in the PF8121 data sheet

2 Features and benefits

- · Up to seven high efficiency buck converters
- · Four linear regulators with load switch options
- RTC supply and coin cell charger
- · Watchdog monitoring
- Independent OV/UV monitoring circuits
- · One-time programmable device configuration
- 3.4 MHz I²C communication interface
- 56-pin 8 x 8 QFN package

Applications 3

- IoT devices
- · High-end consumer and industrial

4 Ordering information

Table 1. Ordering Information

Type number ^[1]	Package				
	Name	Description	Version		
MC32PF8121F1EP		HVQFN56, plastic, thermally enhanced very thin quad; flat non-leaded package, 56 terminals; 0.5 mm pitch; 8 mm x 8 mm x 0.85 mm body	SOT684-21		

[1] To order parts in tape and reel, add the R2 suffix to the part number.

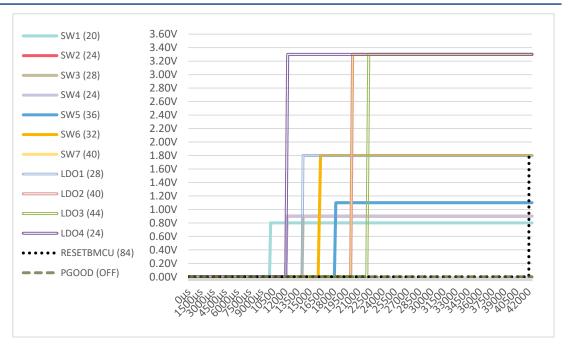


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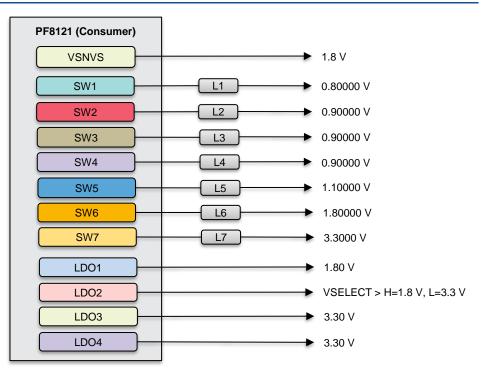
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5 Power up sequence summary



6 Hardware configuration diagram



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7 OTP configuration

See PF8121 data sheet for parametric details. The OTP configuration summary for F1 (sequence ID) is provided in Table 2, Table 3 and Table 4.

Table 2. Device OTP configuration

Functional block	Feature	OTP selection
I ² C settings	Device address	0x08
	I ² C CRC	Disabled
VIN OV lockout	VIN_OVLO	Enabled
	VIN_OVLO shutdown	Disabled
	VIN_OVLO debounce	100 µs
Power good	PG check on power up	RESETBMCU released only if all supplies are in regulation
	PGOOD pin operation	Power good indicator
	PGOOD pin controled by	SW1, SW2, SW3, SW4, SW5, SW6, SW7, LDO1, LDO2, LDO3, LDO4
PWRON control	Power on event detection	Level sensitive
	PWRON debounce	32 ms
	TRESET time	2 sec
	TRESET behavior	PMIC shutdown
STANDBY control	STANDBY polarity	STANDBY active high
EWARN timer	EWARN delay	0.1 ms before power down sequence
XFAILB pin	XFAIL operation	XFAILB operation disabled
FSOB control	FSOB operating mode	Fault status mode
	Assertion on hard-fault event	Disabled
	Assertion on WD timer event	Disabled
	Assertion on WDI event	Disabled
	Assertion on soft-fault event	Disabled
WDI control	WDI reset type	Hard WD reset
	WDI polarity	WDI event detected on falling edge
	WDI detection in standby	Disabled
	Regulators affected by WDI event	Regulator Affected by Soft WD reset: N/A
Watchdog timer	WD timer	Disabled at power-up
control	WD clear window	100 % window
	WD window duration	1024 ms
	Expire fails before WD event	8
	Maximum WD event counter	16
	WD timer in standby	Disabled
Frequency control	Nominal switching frequency	2.5 MHz
	SYNCOUT operation	Disabled
	SYNCIN operation	Disabled
	Frequency spread spectrum	Disabled

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Table 2. Device OTP configuration

Functional block	Feature	OTP selection
Fault management	Fault timer	Disabled
	Maximum fault counter	Disabled
	OV bypass selection	No OV bypass selected
	UV bypass selection	No UV bypass selected
	ILIM bypass selection	No ILIM bypass selected
Switching mode	Default SW operating mode	PWM

Table 3. Sequencer OTP configuration

Functional block	Feature	OTP selection
Power up sequencing	Sequencer TBASE	500 µs
	SW1 sequence slot	20
	SW2 sequence slot	24
	SW3 sequence slot	28
	SW4 sequence slot	24
	SW5 sequence slot	36
	SW6 sequence slot	32
	SW7 sequence slot	40
	LDO1 sequence slot	28
	LDO2 sequence slot	40
	LDO3 sequence slot	44
	LDO4 sequence slot	24
	RESETBMCU sequence slot	84
	PGOOD sequence slot	PGOOD not set in sequence
Power down	Power down mode	Mirror power up sequence
Sequencing	SW1 power down group	Group 4 (1st)
	SW2 power down group	Group 4 (1st)
	SW3 power down group	Group 4 (1st)
	SW4 power down group	Group 4 (1st)
	SW5 power down group	Group 4 (1st)
	SW6 power down group	Group 4 (1st)
	SW7 power down group	Group 4 (1st)
	LDO1 power down group	Group 4 (1st)
	LDO2 power down group	Group 4 (1st)
	LDO3 power down group	Group 4 (1st)
	LDO4 power down group	Group 4 (1st)
	PGOOD power down group	Group 4 (1st)
	RESETBMCU power down	Group 4 (1st)
	group	
	RESETBMCU group delay	10 µs
	Group 1 power down delay	120 µs
	Group 2 power down delay	120 µs
	Group 3 power down delay	120 µs
	Group 4 power down delay	120 µs
	Power down delay	5.0 ms

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Functional block	tors OTP configuration Feature	OTP selection
SW1	Output voltage	0.8 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	0°
	Output inductor	1.0 μH
SW2	Output voltage	0.9 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	225°
	Output inductor	1.0 μH
SW3	Output voltage	0.9 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	0°
	Output inductor	1.0 μH
SW4	Output voltage	0.9 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	270°
	Output inductor	1.0 μH
SW5	Output voltage	1.1 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	315°
	Output inductor	1.0 μH
SW6	Output voltage	1.8 V
(Single phase)	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	DVS ramp	6.25 mV/µs
	Switching phase	135°
	Output inductor	1.0 μH
	VTT mode	Disabled
SW7	Output voltage	3.3 V
	Current limit	4.5 A
	OV detection threshold	107 %
	UV detection threshold	93 %
	Switching phase	45°
	Output inductor	1.0 μΗ

Table 4. Regulators OTP configuration

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Table 4. Regulators OTP configuration Functional block Feature **OTP** selection LDO1 regulator Output voltage 1.8 V OV detection threshold 107 % UV detection threshold 93 % LDO mode Operating mode LDO2 regulator Output voltage 3.3 V OV detection threshold 107 % UV detection threshold 93 % Operating mode LDO mode LDO2EN hardware control Disabled VSELECT hardware control Enabled LDO3 regulator Output voltage 3.3 V OV detection threshold 107 % UV detection threshold 93 % Operating mode LDO mode LDO4 regulator Output voltage 3.3 V OV detection threshold 107 % UV detection threshold 93 %

Operating mode

Coin cell voltage

Output voltage

LDO mode

1.8 V

3.0 V

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> Date of release: 13 March 2019 Document identifier: R_PF8121F1